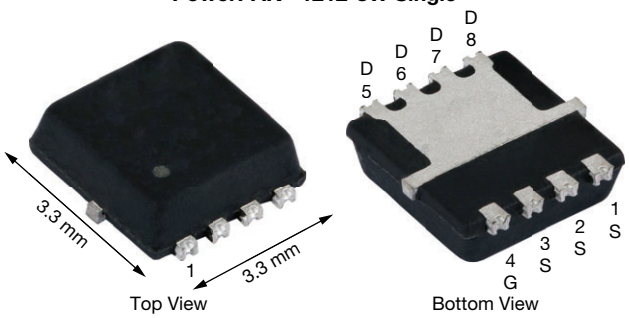
# Automotive P-Channel 100 V (D-S) 175 °C MOSFET

**PowerPAK® 1212-8W Single**




Top View | Bottom View

**Marking code:** Q064

## FEATURES

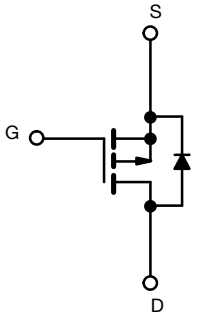
- TrenchFET® power MOSFET
- AEC-Q101 qualified
- 100 % $R_g$ and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

AUTOMOTIVE GRADE

Pb-free

RoHS COMPLIANT

HALOGEN FREE




P-Channel MOSFET

| PRODUCT SUMMARY | |
|---|---|
| $V_{DS}$ (V) | -100 |
| $R_{DS(on)}$ (Ω) at $V_{GS}$ = -10 V | 0.0800 |
| $R_{DS(on)}$ (Ω) at $V_{GS}$ = -4.5 V | 0.1100 |
| $I_D$ (A) | -16 |
| Configuration | Single |

| ORDERING INFORMATION | |
|---|---|
| Package | PowerPAK 1212-8W |
| Lead (Pb)-free and halogen-free | SQS201CENW (for detailed order number please see www.vishay.com/doc?79776) |

**ABSOLUTE MAXIMUM RATINGS** ($T_C$ = 25 °C, unless otherwise noted)

| PARAMETER | | SYMBOL | LIMIT | UNIT |
|---|---|---|---|---|
| Drain-source voltage | | $V_{DS}$ | -100 | V |
| Gate-source voltage | | $V_{GS}$ | ± 20 | |
| Continuous drain current | $T_C$ = 25 °C [a] | $I_D$ | -16 | A |
| | $T_C$ = 125 °C | | -11.4 | |
| Continuous source current (diode conduction) [a] | | $I_S$ | -16 | |
| Pulsed drain current [b] | | $I_{DM}$ | -46 | |
| Single pulse avalanche current | L = 0.1 mH | $I_{AS}$ | -22 | |
| Single pulse avalanche energy | | $E_{AS}$ | 24.2 | mJ |
| Maximum power dissipation | $T_C$ = 25 °C | $P_D$ | 62.5 | W |
| | $T_C$ = 125 °C | | 20 | |
| Operating junction and storage temperature range | | $T_J$, $T_{stg}$ | -55 to +175 | °C |
| Soldering recommendations (peak temperature) [d, e] | | | 260 | |

**THERMAL RESISTANCE RATINGS**

| PARAMETER | | SYMBOL | LIMIT | UNIT |
|---|---|---|---|---|
| Junction-to-ambient | PCB mount [c] | $R_{thJA}$ | 81 | °C/W |
| Junction-to-case (drain) | | $R_{thJC}$ | 2.4 | |

**Notes**

a. Package limited
b. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %
c. When mounted on 1" square PCB (FR4 material)
d. See solder profile (www.vishay.com/doc?73257). The PowerPAK1212-8W package may have visible exposed Cu at the end of the lead terminals due to the singulation process. However, the leads also have plated indents on the top and bottom surfaces that promote the formation of a solder fillet compatible with automated optical inspection methods
e. Rework conditions: manual soldering with a soldering iron is not recommended

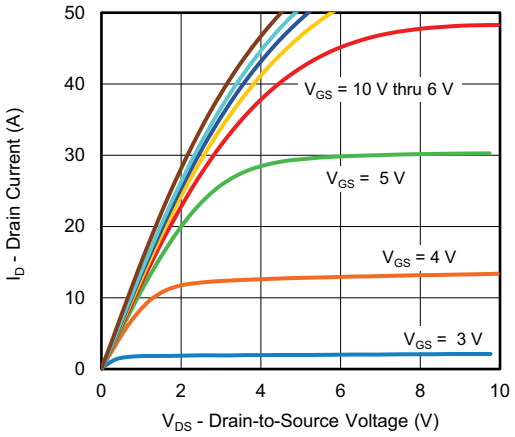
| **SPECIFICATIONS** ($T_C$ = 25 °C, unless otherwise noted) | | | | | | | |
|---|---|---|---|---|---|---|---|
| **PARAMETER** | **SYMBOL** | **TEST CONDITIONS** | | **MIN.** | **TYP.** | **MAX.** | **UNIT** |
| **Static** | | | | | | | |
| Drain-source breakdown voltage | $V_{DS}$ | $V_{GS}$ = 0, $I_D$ = -250 µA | | -100 | - | - | V |
| Gate-source threshold voltage | $V_{GS(th)}$ | $V_{DS}$ = $V_{GS}$, $I_D$ = -250 µA | | -1.5 | -2.0 | -2.5 | |
| Gate-source leakage | $I_{GSS}$ | $V_{DS}$ = 0 V, $V_{GS}$ = ± 20 V | | - | - | ± 100 | nA |
| Zero gate voltage drain current | $I_{DSS}$ | $V_{GS}$ = 0 V | $V_{DS}$ = -100 V | - | - | -1 | µA |
| | | $V_{GS}$ = 0 V | $V_{DS}$ = -100 V, $T_J$ = 125 °C | - | - | -50 | |
| | | $V_{GS}$ = 0 V | $V_{DS}$ = -100 V, $T_J$ = 175 °C | - | - | -200 | |
| On-state drain current [a] | $I_{D(on)}$ | $V_{GS}$ = -10 V | $V_{DS}$ ≥ -5 V | -10 | - | - | A |
| Drain-source on-state resistance [a] | $R_{DS(on)}$ | $V_{GS}$ = -10 V | $I_D$ = -6 A | - | 0.0650 | 0.0800 | Ω |
| | | $V_{GS}$ = -10 V | $I_D$ = -6 A, $T_J$ = 125 °C | - | - | 0.1330 | |
| | | $V_{GS}$ = -10 V | $I_D$ = -6 A, $T_J$ = 175 °C | - | - | 0.1600 | |
| | | $V_{GS}$ = -4.5 V | $I_D$ = -4 A | - | 0.0860 | 0.1100 | |
| Forward transconductance [b] | $g_{fs}$ | $V_{DS}$ = -15 V, $I_D$ = -6 A | | - | 12 | - | S |
| **Dynamic [b]** | | | | | | | |
| Input capacitance | $C_{iss}$ | $V_{GS}$ = 0 V | $V_{DS}$ = -25 V, f = 1 MHz | - | 949 | 1330 | pF |
| Output capacitance | $C_{oss}$ | | | - | 421 | 590 | |
| Reverse transfer capacitance | $C_{rss}$ | | | - | 30 | 42 | |
| Total gate charge [c] | $Q_g$ | $V_{GS}$ = -10 V | $V_{DS}$ = -50 V, $I_D$ = -4 A | - | 17.4 | 26 | nC |
| Gate-source charge [c] | $Q_{gs}$ | | | - | 3.5 | - | |
| Gate-drain charge [c] | $Q_{gd}$ | | | - | 3.3 | - | |
| Gate resistance | $R_g$ | f = 1 MHz | | 4.9 | 9.82 | 14.8 | Ω |
| Turn-on delay time [c] | $t_{d(on)}$ | $V_{DD}$ = -50 V, $R_L$ = 12.5 Ω<br>$I_D$ ≅ -4 A, $V_{GEN}$ = -10 V, $R_g$ = 1 Ω | | - | 9 | 14 | ns |
| Rise time [c] | $t_r$ | | | - | 4 | 7 | |
| Turn-off delay time [c] | $t_{d(off)}$ | | | - | 30 | 45 | |
| Fall time [c] | $t_f$ | | | - | 9 | 14 | |
| **Source-Drain Diode Ratings and Characteristic [b]** | | | | | | | |
| Pulsed current [a] | $I_{SM}$ | | | - | - | -46 | A |
| Forward voltage | $V_{SD}$ | $I_F$ = -6 A, $V_{GS}$ = 0 V | | - | -0.86 | -1.1 | V |
| Body diode reverse recovery time | $t_{rr}$ | $I_F$ = -5 A, di/dt = 100 A/µs | | - | 45 | 90 | ns |
| Body diode reverse recovery charge | $Q_{rr}$ | | | - | 105 | 210 | nC |
| Reverse recovery fall time | $t_a$ | | | - | 39 | - | ns |
| Reverse recovery rise time | $t_b$ | | | - | 6 | - | |
| Body diode peak reverse recovery current | $I_{RM(REC)}$ | | | - | -4.89 | - | A |

**Notes**

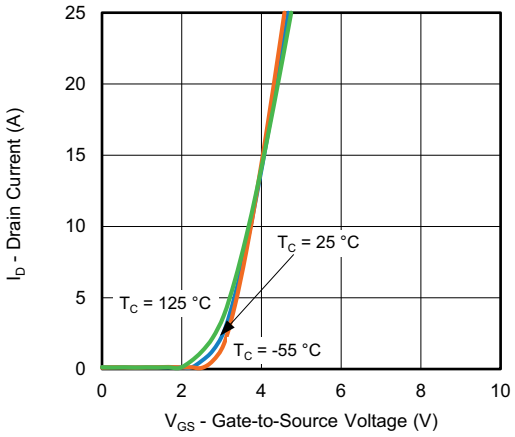
a. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %
b. Guaranteed by design, not subject to production testing
c. Independent of operating temperature

*Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.*

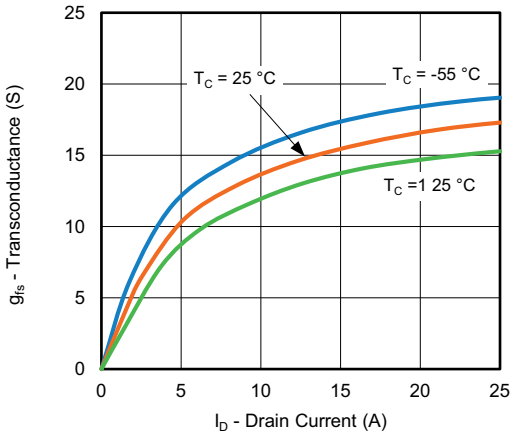
## TYPICAL CHARACTERISTICS ($T_A$ = 25 °C, unless otherwise noted)



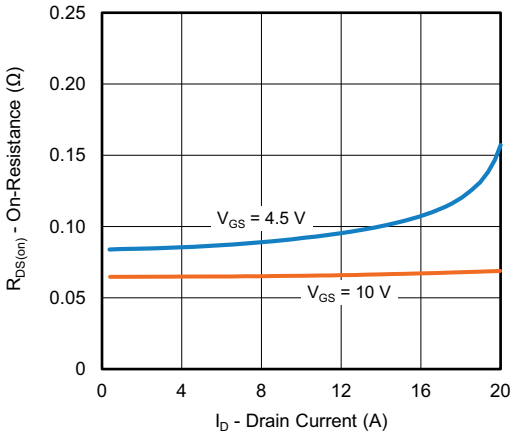

**Output Characteristics**



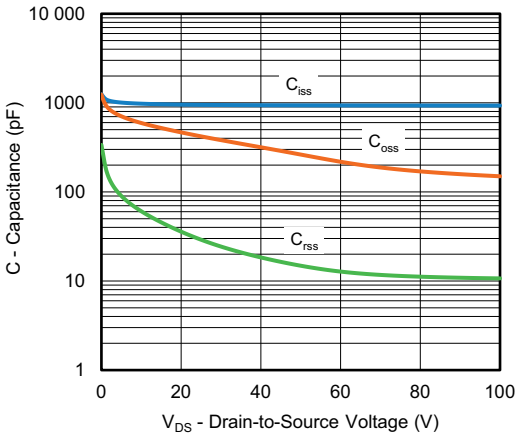

**Transfer Characteristics**



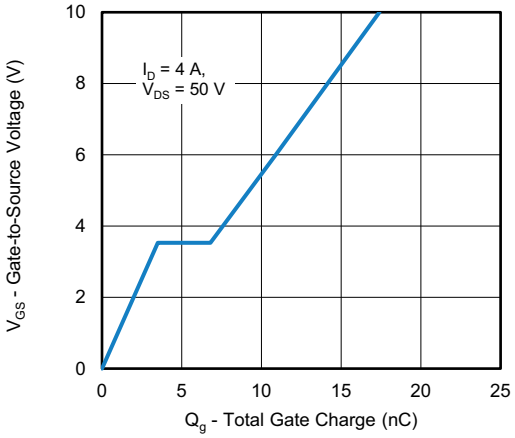

**Transconductance**




**On-Resistance vs. Drain Current**

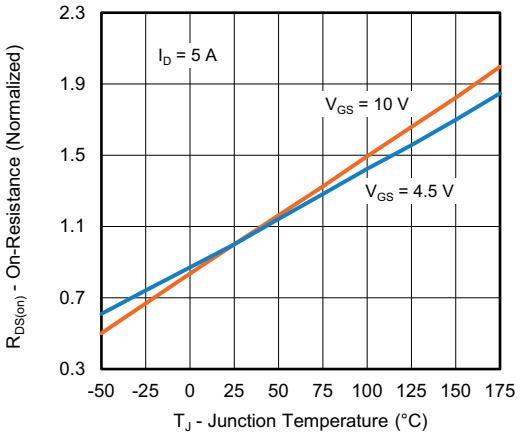



**Capacitance**

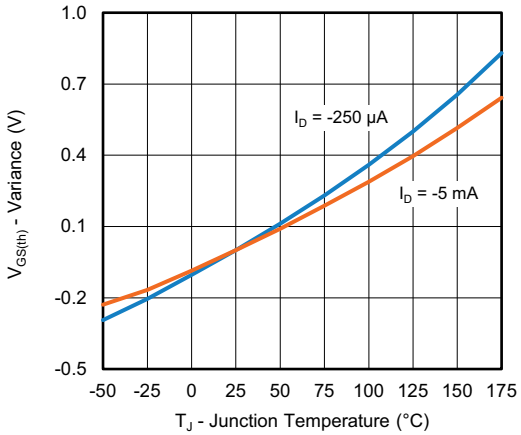



**Gate Charge**

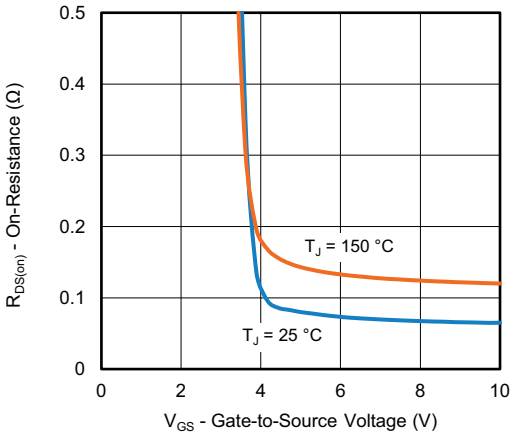
## TYPICAL CHARACTERISTICS ($T_A$ = 25 °C, unless otherwise noted)



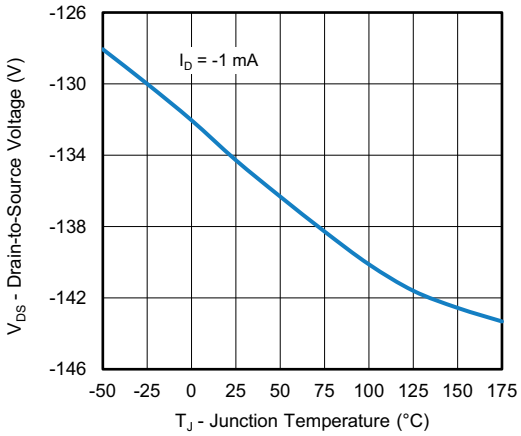

**On-Resistance vs. Junction Temperature**



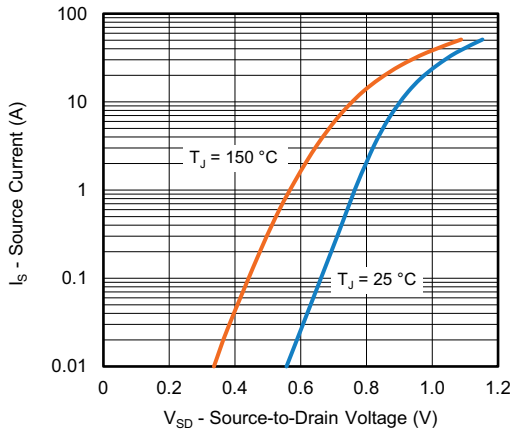

**Threshold Voltage**



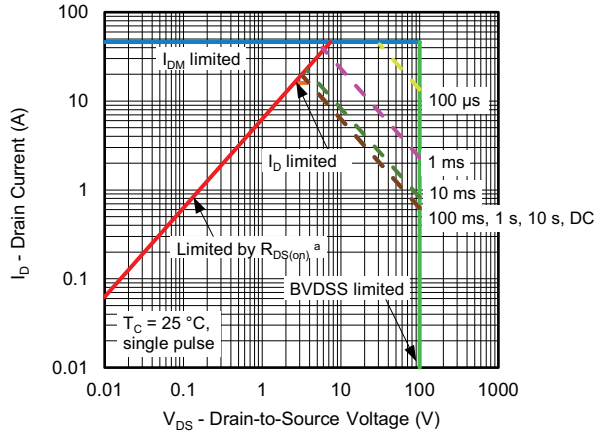

**On-Resistance vs. Gate-to-Source Voltage**




**Drain Source Breakdown vs. Junction Temperature**




**Source Drain Diode Forward Voltage**

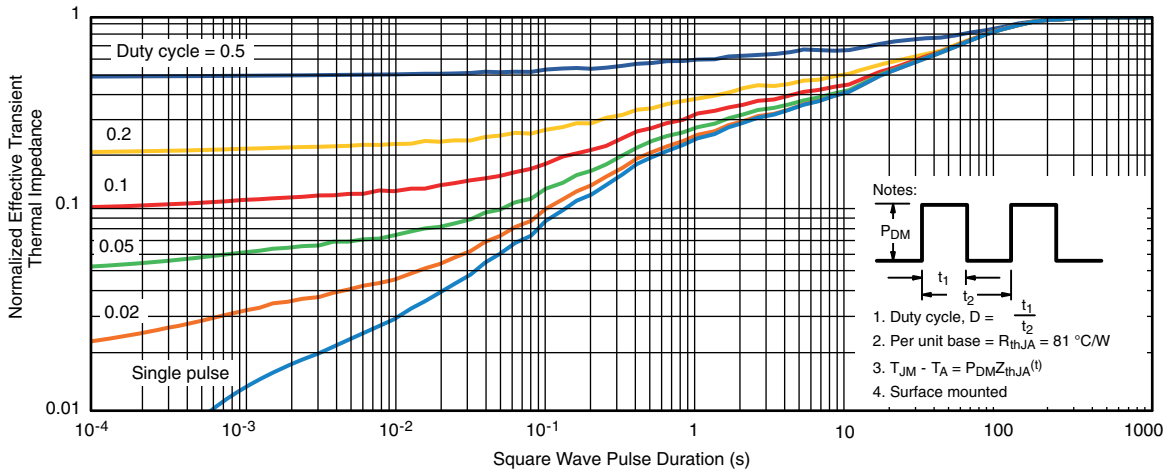



**Safe Operating Area**

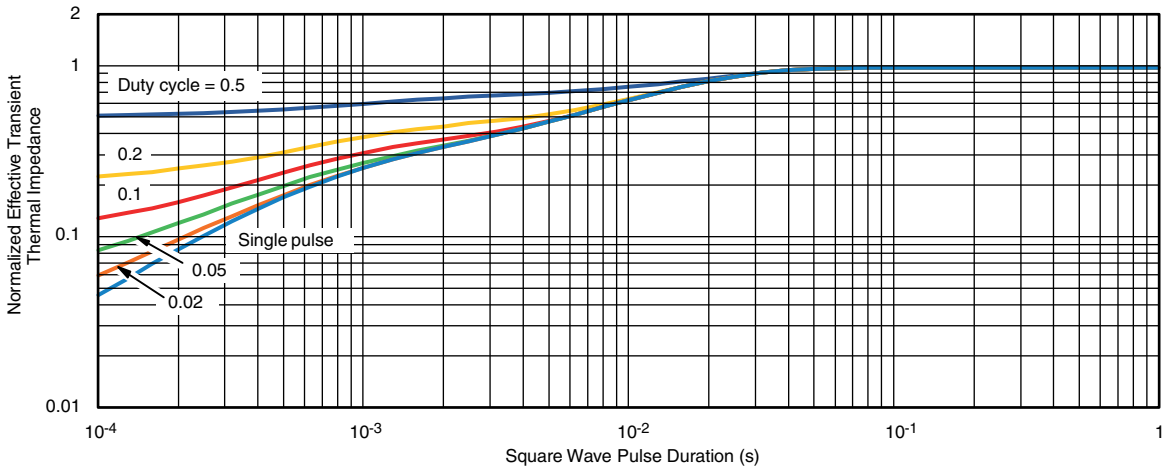
**Note**

a. $V_{GS}$ > minimum $V_{GS}$ at which $R_{DS(on)}$ is specified

**THERMAL RATINGS** ($T_A$ = 25 °C, unless otherwise noted)




**Normalized Thermal Transient Impedance, Junction-to-Ambient**




**Normalized Thermal Transient Impedance, Junction-to-Case**

**Note**

- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
  - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

  are given for general guidelines only to enable the user to get a “ball park” indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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